Onsemi

150 mA

NCP170

The NCP170 series of CMOS low dropout regulators are designed specifically for portable battery-powered applications which require ultra-low quiescent current. The ultra-low consumption of typ. 500 nA ensures long battery life and dynamic transient boost feature improves device transient response for wireless communication applications. The device is available in small 1×1 mm XDFN4, SOT-563 and TSOP-5 packages.

Features

- Operating Input Voltage Range: 2.2 V to 5.5 V
- Output Voltage Range: 1.2 V to 3.6 V (0.1 V Steps)
- Ultra-Low Quiescent Current Typ. 0.5 μA
- Low Dropout: 170 mV Typ. at 150 mA
- High Output Voltage Accuracy ±1%
- Stable with Ceramic Capacitors 1 µF
- Over-Current Protection
- Thermal Shutdown Protection
- NCP170A for Active Discharge Option
- Available in Small 1 × 1 mm XDFN4, SOT-563 and TSOP-5 Packages
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Typical Applications

- Battery Powered Equipments
- Portable Communication Equipments
- Cameras, Image Sensors and Camcorders

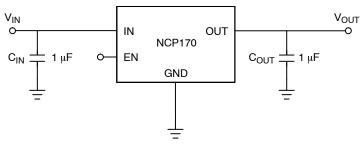


Figure 1. Typical Application Schematic



XDFN4 **MX SUFFIX** CASE 711AJ

SOT-563 **XV SUFFIX** CASE 463A

TSOP-5 **SN SUFFIX CASE 483**

MARKING DIAGRAMS



= Date Code М





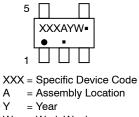
XX = Specific Device Code

= Month Code М

= Pb-Free Package

*Pb-Free indicator, "G" or microdot "." may or may not be present.

TSOP-5



= Work Week W

Α

= Pb-Free Package (Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering, marking and shipping information on page 22 of this data sheet.

PIN FUNCTION DESCRIPTION

Pin No. XDFN4	Pin No. SOT-563	Pin No. TSOP-5	Pin Name	Description
4	1	1	IN	Power Supply Input Voltage
2	2	2	GND	Power Supply Ground
3	6	3	EN	Chip Enable Pin (Active "H")
1	3	5	OUT	Output Pin
EPAD	-	-	EPAD	Internally Connected to GND
-	4	4	NC	No Connect
-	5	-	GND	Power Supply Ground

ABSOLUTE MAXIMUM RATINGS

Symbol	Rating	Value	Unit
V _{IN}	Input Voltage (Note 1)	6.0	V
V _{OUT}	Output Voltage	–0.3 to V _{IN} + 0.3	V
V _{CE}	Chip Enable Input	-0.3 to 6.0	V
T _{J(MAX)}	Maximum Junction Temperature	150	°C
T _{STG}	Storage Temperature	–55 to 150	°C
ESD _{HBM}	ESD Capability, Human Body Model (Note 2)	2000	V
ESD _{MM}	ESD Capability, Machine Model (Note 2)	200	V

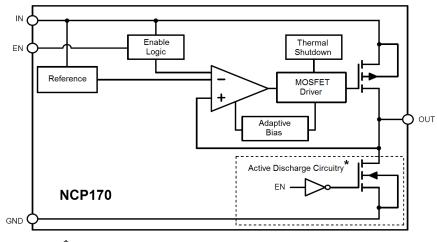
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Refer to ELECTRICAL CHARACTERISTICS and APPLICATION INFORMATION for Safe Operating Area.

2. This device series incorporates ESD protection and is tested by the following methods:

ESD Human Body Model tested per AEC-Q100-002 (EIA/JESD22-A114) ESD Machine Model tested per AEC-Q100-003 (EIA/JESD22-A115) Latchup Current Maximum Rating tested per JEDEC standard: JESD78

THERMAL CHARACTERISTICS

Symbol	Rating	Value	Unit
R _{θJA}	Thermal Characteristics, Thermal Resistance, Junction-to-Air XDFN4 1 \times 1 mm SOT-563 TSOP-5	250 200 250	°C/W



* Active discharge feature is present only in NCP170AxxvvvTyG devices.

Figure 2. Simplified Block Diagram

ELECTRICAL CHARACTERISTICS - VOLTAGE VERSION 1.2 V

 $(-40^{\circ}C \leq T_{J} \leq 85^{\circ}C; V_{IN} = 2.5 \text{ V}; I_{OUT} = 1 \text{ mA}, C_{IN} = C_{OUT} = 1.0 \text{ }\mu\text{F}, \text{ unless otherwise noted}. Typical values are at T_{A} = +25^{\circ}C.) \text{ (Note 3)}$

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
V _{IN}	Operating Input Voltage		2.2	-	5.5	V
V _{OUT}	Output Voltage	$T_A = +25^{\circ}C$	1.188	1.2	1.212	V
		$-40^{\circ}C \le T_J \le 85^{\circ}C$	1.176	1.2	1.224	
Line _{Reg}	Line Regulation	$2.5 \text{ V} < \text{V}_{\text{IN}} \le 5.5 \text{ V}, \text{ I}_{\text{OUT}} = 1 \text{ mA}$	-	0.05	0.20	%/V
Load _{Reg}	Load Regulation	0 mA < I _{OUT} \leq 150 mA, V _{IN} = 2.5 V	-20	1	20	mV
V _{DO}	Dropout Voltage	(Note 4)	-	-	-	mV
I _{OUT}	Output Current	(Note 5)	150	-	-	mA
I _{SC}	Short Circuit Current Limit	V _{OUT} = 0 V	-	225	-	mA
l _Q	Quiescent Current	I _{OUT} = 0 mA	-	0.5	0.9	μΑ
I _{STB}	Standby Current	$V_{EN} = 0 \text{ V}, \text{T}_{\text{J}} = 25^{\circ}\text{C}$	-	0.1	0.5	μA
V _{ENH}	EN Pin Threshold Voltage	EN Input Voltage "H"	1.2	-	-	V
V _{ENL}	EN Pin Threshold Voltage	EN Input Voltage "L"	-	-	0.4	V
I _{EN}	EN Pin Current	$V_{EN} \le V_{IN} \le 5.5 \text{ V} \text{ (Note 6)}$	-	10	-	nA
PSRR	Power Supply Rejection Ratio	f = 1 kHz, V_{IN} = 2.2 V + 200 mVpp Modulation I _{OUT} = 150 mA I _{OUT} = 10 mA		57 63		dB
V _{NOISE}	Output Noise Voltage	V_{IN} = 5.5 V, I_{OUT} = 1 mA, f = 100 Hz to 1 MHz, C_{OUT} = 1 μF	-	85	-	μVrms
R _{LOW}	Active Output Discharge Resistance (A option only)	V _{IN} = 5.5 V, V _{EN} = 0 V (Note 6)	-	100	-	Ω
T _{SD}	Thermal Shutdown Temperature	Temperature Increasing from $T_J = +25^{\circ}C$ (Note 6)	-	175	-	°C
T _{SDH}	Thermal Shutdown Hysteresis	Temperature Falling from T _{SD} (Note 6)	-	25	_	°C

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Performance guaranteed over the indicated operating temperature range by design and/or characterization production tested at T_J = T_A = 25°C. Low duty cycle pulse techniques are used during testing to maintain the junction temperature as close to ambient as possible.
 Not Characterized at V_{IN} = 2.2 V, V_{OUT} = 1.2 V, I_{OUT} = 150 mA.

5. Respect SOA.

ELECTRICAL CHARACTERISTICS - VOLTAGE VERSION 1.5 V

 $(-40^{\circ}C \le T_J \le 85^{\circ}C; V_{IN} = 2.5 \text{ V}; I_{OUT} = 1 \text{ mA}, C_{IN} = C_{OUT} = 1.0 \mu\text{F}, \text{ unless otherwise noted}. Typical values are at T_A = +25^{\circ}C.)$ (Note 7)

Symbol	Parameter	Test Conditions	Min	Тур	Мах	Unit
V _{IN}	Operating Input Voltage		2.2	-	5.5	V
V _{OUT}	Output Voltage	$T_A = +25^{\circ}C$	1.485	1.5	1.515	V
		$-40^{\circ}C \le T_J \le 85^{\circ}C$	1.470	1.5	1.530	
Line _{Reg}	Line Regulation	$4.3 \text{ V} < \text{V}_{\text{IN}} \le 5.5 \text{ V}, \text{ I}_{\text{OUT}} = 1 \text{ mA}$	-	0.05	0.20	%/V
Load _{Reg}	Load Regulation	0 mA < I _{OUT} \leq 150 mA, V _{IN} = 4.3 V	-20	-	20	mV
V_{DO}	Dropout Voltage	I _{OUT} = 150 mA (Note 8)	-	-	-	mV
I _{OUT}	Output Current	(Note 9)	150	-	-	mA
I _{SC}	Short Circuit Current Limit	V _{OUT} = 0 V	-	225	-	mA
Ι _Q	Quiescent Current	I _{OUT} = 0 mA	-	0.5	0.9	μΑ
I _{STB}	Standby Current	$V_{EN} = 0 \text{ V}, \text{ T}_{J} = 25^{\circ}\text{C}$	-	0.1	0.5	μΑ
V _{ENH}	EN Pin Threshold Voltage	EN Input Voltage "H"	1.2	-	-	V
V _{ENL}	EN Pin Threshold Voltage	EN Input Voltage "L"	-	-	0.4	V
I _{EN}	EN Pin Current	$V_{EN} \le V_{IN} \le 5.5 \text{ V}$ (Note 10)	-	10	-	nA
PSRR	Power Supply Rejection Ratio	f = 1 kHz, V_{IN} = 2.5 V + 200 mVpp Modulation I _{OUT} = 150 mA	-	57	-	dB
V _{NOISE}	Output Noise Voltage	V_{IN} = 5.5 V, I_{OUT} = 1 mA, f = 100 Hz to 1 MHz, C_{OUT} = 1 μ F	-	90	-	μVrms
R _{LOW}	Active Output Discharge Resistance (A option only)	V _{IN} = 5.5 V, V _{EN} = 0 V (Note 10)	-	100	-	Ω
T _{SD}	Thermal Shutdown Temperature	Temperature Increasing from $T_J = +25^{\circ}C$ (Note 10)	-	175	-	°C
T _{SDH}	Thermal Shutdown Hysteresis	Temperature Falling from T _{SD} (Note 10)	-	25	-	°C

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 7. Performance guaranteed over the indicated operating temperature range by design and/or characterization production tested at

Performance guaranteed over the indicated operating temperature range by design and/or characterization production tested at T_J = T_A = 25°C. Low duty cycle pulse techniques are used during testing to maintain the junction temperature as close to ambient as possible.
 Not Characterized at V_{IN} = 2.2 V, V_{OUT} = 1.5 V, I_{OUT} = 150 mA.

9. Respect SOA.

ELECTRICAL CHARACTERISTICS - VOLTAGE VERSION 1.8 V

 $(-40^{\circ}C \le T_J \le 85^{\circ}C; V_{IN} = 2.8 \text{ V}; I_{OUT} = 1 \text{ mA}, C_{IN} = C_{OUT} = 1.0 \mu\text{F}, \text{ unless otherwise noted}. Typical values are at T_A = +25^{\circ}C.)$ (Note 11)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
V _{IN}	Operating Input Voltage		2.2	-	5.5	V
		I _{OUT} < 30 mA	2.0	-	5.5	
V _{OUT}	Output Voltage	$T_A = +25^{\circ}C$	1.782	1.8	1.818	V
		$-40^{\circ}C \le T_J \le 85^{\circ}C$	1.764	1.8	1.836	
Line _{Reg}	Line Regulation	$2.8 \text{ V} < \text{V}_{\text{IN}} \le 5.5 \text{ V}, \text{ I}_{\text{OUT}} = 1 \text{ mA}$	-	0.05	0.20	%/V
Load _{Reg}	Load Regulation	0 mA < I _{OUT} \leq 150 mA, V _{IN} = 2.8 V	-20	1	20	mV
V _{DO}	Dropout Voltage	I _{OUT} = 150 mA (Note 12)	-	350	480	mV
I _{OUT}	Output Current	(Note 13)	150	-	-	mA
I _{SC}	Short Circuit Current Limit	V _{OUT} = 0 V	-	225	-	mA
l _Q	Quiescent Current	I _{OUT} = 0 mA	-	0.5	0.9	μΑ
I _{STB}	Standby Current	$V_{EN} = 0 V, T_{J} = 25^{\circ}C$	-	0.1	0.5	μΑ
V _{ENH}	EN Pin Threshold Voltage	EN Input Voltage "H"	1.2	-	-	V
V _{ENL}	EN Pin Threshold Voltage	EN Input Voltage "L"	-	-	0.4	V
I _{EN}	EN Pull Down Current	$V_{EN} \le V_{IN} \le 5.5 \text{ V}$ (Note 14)	-	10	-	nA
PSRR	Power Supply Rejection Ratio	f = 1 kHz, V_{IN} = 2.8 V + 200 mVpp Modulation I _{OUT} = 150 mA	-	57	-	dB
V _{NOISE}	Output Noise Voltage	V _{IN} = 5.5 V, I _{OUT} = 1 mA f = 100 Hz to 1 MHz, C _{OUT} = 1 μF	-	95	-	μVrms
R _{LOW}	Active Output Discharge Resistance (A option only)	V _{IN} = 5.5 V, V _{EN} = 0 V (Note 14)	-	100	-	Ω
T _{SD}	Thermal Shutdown Temperature	Temperature Increasing from $T_J = +25^{\circ}C$ (Note 14)	-	175	-	°C
T _{SDH}	Thermal Shutdown Hysteresis	Temperature Falling from T _{SD} (Note 14)	-	25	_	°C

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

11. Performance guaranteed over the indicated operating temperature range by design and/or characterization production tested at $T_J = T_A = 25^{\circ}$ C. Low duty cycle pulse techniques are used during testing to maintain the junction temperature as close to ambient as possible. 12. Characterized when V_{OUT} falls 54 mV below the regulated voltage and only for devices with V_{OUT} = 1.8 V.

13. Respect SOA.

ELECTRICAL CHARACTERISTICS - VOLTAGE VERSION 1.9 V

 $(-40^{\circ}C \le T_J \le 85^{\circ}C; V_{IN} = 2.9 V; I_{OUT} = 1 \text{ mA}, C_{IN} = C_{OUT} = 1.0 \mu\text{F}$, unless otherwise noted. Typical values are at $T_A = +25^{\circ}C$.) (Note 15)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
V _{IN}	Operating Input Voltage		2.2	-	5.5	V
V _{OUT}	Output Voltage	$T_A = +25^{\circ}C$	1.881	1.9	1.919	V
		$-40^{\circ}C \le T_J \le 85^{\circ}C$	1.862	1.9	1.938	
Line _{Reg}	Line Regulation	$3.5 \text{ V} < \text{V}_{\text{IN}} \leq 5.5 \text{ V}, \text{ I}_{\text{OUT}} = 1 \text{ mA}$	-	0.05	0.20	%/V
Load _{Reg}	Load Regulation	0 mA < I _{OUT} \leq 150 mA, V _{IN} = 3.5 V	-20	1	20	mV
V _{DO}	Dropout Voltage	I _{OUT} = 150 mA (Note 16)	-	335	460	mV
I _{OUT}	Output Current	(Note 17)	150	-	-	mA
I _{SC}	Short Circuit Current Limit	V _{OUT} = 0 V	-	225	-	mA
Ι _Q	Quiescent Current	I _{OUT} = 0 mA	-	0.5	0.9	μΑ
I _{STB}	Standby Current	$V_{EN} = 0 \text{ V}, \text{T}_{\text{J}} = 25^{\circ}\text{C}$	-	0.1	0.5	μΑ
V _{ENH}	EN Pin Threshold Voltage	EN Input Voltage "H"	1.2	-	-	V
V _{ENL}	EN Pin Threshold Voltage	EN Input Voltage "L"	-	-	0.4	V
I _{EN}	EN Pull Down Current	$V_{EN} \le V_{IN} \le 5.5 \text{ V} \text{ (Note 18)}$	-	10	-	nA
PSRR	Power Supply Rejection Ratio	f = 1 kHz, V_{IN} = 3.5 V + 200 mVpp Modulation I_{OUT} = 150 mA	-	57	-	dB
V _{NOISE}	Output Noise Voltage	V_{IN} = 5.5 V, I_{OUT} = 1 mA f = 100 Hz to 1 MHz, C_{OUT} = 1 μF	-	100	-	μVrms
R _{LOW}	Active Output Discharge Resistance (A option only)	V _{IN} = 5.5 V, V _{EN} = 0 V (Note 18)	-	100	-	Ω
T _{SD}	Thermal Shutdown Temperature	Temperature Increasing from $T_J = +25^{\circ}C$ (Note 18)	-	175	-	°C
T _{SDH}	Thermal Shutdown Hysteresis	Temperature Falling from T _{SD} (Note 18)	-	25	-	°C

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 15. Performance guaranteed over the indicated operating temperature range by design and/or characterization production tested at

15. Performance guaranteed over the indicated operating temperature range by design and/or characterization production tested at T_J = T_A = 25°C. Low duty cycle pulse techniques are used during testing to maintain the junction temperature as close to ambient as possible.
 16. Characterized when V_{OUT} falls 57 mV below the regulated voltage and only for devices with V_{OUT} = 1.9 V.

17. Respect SOA.

ELECTRICAL CHARACTERISTICS - VOLTAGE VERSION 2.5 V

 $(-40^{\circ}C \le T_J \le 85^{\circ}C; V_{IN} = 3.5 \text{ V}; I_{OUT} = 1 \text{ mA}, C_{IN} = C_{OUT} = 1.0 \mu\text{F}, \text{ unless otherwise noted}. Typical values are at T_A = +25^{\circ}C.)$ (Note 19)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
V _{IN}	Operating Input Voltage		2.2	-	5.5	V
V _{OUT}	Output Voltage	$T_A = +25^{\circ}C$	2.475	2.5	2.525	V
		$-40^{\circ}C \le T_J \le 85^{\circ}C$	2.450	2.5	2.550	
Line _{Reg}	Line Regulation	$3.5 \text{ V} < \text{V}_{\text{IN}} \leq 5.5 \text{ V}, \text{ I}_{\text{OUT}} = 1 \text{ mA}$	-	0.05	0.20	%/V
Load _{Reg}	Load Regulation	0 mA < I _{OUT} \leq 150 mA, V _{IN} = 3.5 V	-20	1	20	mV
V _{DO}	Dropout Voltage	I _{OUT} = 150 mA (Note 20)	-	240	330	mV
I _{OUT}	Output Current	(Note 21)	150	-	-	mA
I _{SC}	Short Circuit Current Limit	V _{OUT} = 0 V	-	225	-	mA
Ι _Q	Quiescent Current	I _{OUT} = 0 mA	-	0.5	0.9	μΑ
I _{STB}	Standby Current	$V_{EN} = 0 \text{ V}, \text{T}_{\text{J}} = 25^{\circ}\text{C}$	-	0.1	0.5	μΑ
V _{ENH}	EN Pin Threshold Voltage	EN Input Voltage "H"	1.2	-	-	V
V _{ENL}	EN Pin Threshold Voltage	EN Input Voltage "L"	-	-	0.4	V
I _{EN}	EN Pull Down Current	$V_{EN} \le V_{IN} \le 5.5 \text{ V}$ (Note 22)	-	10	-	nA
PSRR	Power Supply Rejection Ratio	f = 1 kHz, V_{IN} = 3.5 V + 200 mVpp Modulation I_{OUT} = 150 mA	-	57	-	dB
V _{NOISE}	Output Noise Voltage	V_{IN} = 5.5 V, I_{OUT} = 1 mA f = 100 Hz to 1 MHz, C_{OUT} = 1 μF	-	125	-	μVrms
R _{LOW}	Active Output Discharge Resistance (A option only)	V _{IN} = 5.5 V, V _{EN} = 0 V (Note 22)	-	100	-	Ω
T _{SD}	Thermal Shutdown Temperature	Temperature Increasing from $T_J = +25^{\circ}C$ (Note 22)	-	175	-	°C
T _{SDH}	Thermal Shutdown Hysteresis	Temperature Falling from T _{SD} (Note 22)	-	25	-	°C

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 19. Performance guaranteed over the indicated operating temperature range by design and/or characterization production tested at

Performance guaranteed over the indicated operating temperature range by design and/or characterization production tested at T_J = T_A = 25°C. Low duty cycle pulse techniques are used during testing to maintain the junction temperature as close to ambient as possible.
 Characterized when V_{OUT} falls 75 mV below the regulated voltage and only for devices with V_{OUT} = 2.5 V.

21. Respect SOA.

ELECTRICAL CHARACTERISTICS - VOLTAGE VERSION 2.8 V

 $(-40^{\circ}C \le T_J \le 85^{\circ}C; V_{IN} = 3.8 \text{ V}; I_{OUT} = 1 \text{ mA}, C_{IN} = C_{OUT} = 1.0 \mu\text{F}, \text{ unless otherwise noted}. Typical values are at T_A = +25^{\circ}C.)$ (Note 23)

Symbol	Parameter	Test Conditions	Min	Тур	Мах	Unit
V _{IN}	Operating Input Voltage		2.2	-	5.5	V
V _{OUT}	Output Voltage	$T_A = +25^{\circ}C$	2.772	2.8	2.828	V
		$-40^\circ C \le T_J \le 85^\circ C$	2.744	2.8	2.856	
Line _{Reg}	Line Regulation	3.8 V < V _{IN} \leq 5.5 V, I _{OUT} = 1 mA	-	0.05	0.20	%/V
Load _{Reg}	Load Regulation	0 mA < I_{OUT} \leq 150 mA, V _{IN} = 3.8 V	-20	1	20	mV
V _{DO}	Dropout Voltage	I _{OUT} = 150 mA (Note 24)	-	210	300	mV
I _{OUT}	Output Current	(Note 25)	150	-	-	mA
I _{SC}	Short Circuit Current Limit	V _{OUT} = 0 V	-	195	-	mA
Ι _Q	Quiescent Current	I _{OUT} = 0 mA	-	0.5	0.9	μA
I _{STB}	Standby Current	$V_{EN} = 0 V, T_{J} = 25^{\circ}C$	-	0.1	0.5	μA
V _{ENH}	EN Pin Threshold Voltage	EN Input Voltage "H"	1.2	-	-	V
V _{ENL}	EN Pin Threshold Voltage	EN Input Voltage "L"	-	-	0.4	V
I _{EN}	EN Pull Down Current	$V_{EN} \le V_{IN} \le 5.5 \text{ V}$ (Note 26)	-	10	-	nA
PSRR	Power Supply Rejection Ratio	f = 1 kHz, V _{IN} = 3.8 V + 200 mVpp Modulation I_{OUT} = 150 mA	-	40	-	dB
V _{NOISE}	Output Noise Voltage	V_{IN} = 5.5 V, I_{OUT} = 1 mA f = 100 Hz to 1 MHz, C_{OUT} = 1 μF	-	125	-	μVrms
R _{LOW}	Active Output Discharge Resistance (A option only)	V _{IN} = 5.5 V, V _{EN} = 0 V (Note 26)	-	100	-	Ω
T _{SD}	Thermal Shutdown Temperature	Temperature Increasing from $T_J = +25^{\circ}C$ (Note 26)	-	175	-	°C
T _{SDH}	Thermal Shutdown Hysteresis	Temperature Falling from T _{SD} (Note 26)	-	25	-	°C

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 23.Performance guaranteed over the indicated operating temperature range by design and/or characterization production tested at

23. Performance guaranteed over the indicated operating temperature range by design and/or characterization production tested at T_J = T_A = 25°C. Low duty cycle pulse techniques are used during testing to maintain the junction temperature as close to ambient as possible.
 24. Characterized when V_{OUT} falls 84 mV below the regulated voltage and only for devices with V_{OUT} = 2.8 V.

25. Respect SOA.

ELECTRICAL CHARACTERISTICS - VOLTAGE VERSION 3.0 V

 $(-40^{\circ}C \le T_J \le 85^{\circ}C; V_{IN} = 4.0 \text{ V}; I_{OUT} = 1 \text{ mA}, C_{IN} = C_{OUT} = 1.0 \mu\text{F}, \text{ unless otherwise noted. Typical values are at } T_A = +25^{\circ}C.)$ (Note 27)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
V _{IN}	Operating Input Voltage		2.2	-	5.5	V
V _{OUT}	Output Voltage	$T_A = +25^{\circ}C$	2.97	3.0	3.03	V
		$-40^{\circ}C \leq T_J \leq 85^{\circ}C$	2.94	3.0	3.06	
Line _{Reg}	Line Regulation	4.0 V < V _{IN} \leq 5.5 V, I _{OUT} = 1 mA	-	0.05	0.20	%/V
Load _{Reg}	Load Regulation	0 mA < $I_{OUT} \le$ 150 mA, V_{IN} = 4 V	-20	1	20	mV
V _{DO}	Dropout Voltage	I _{OUT} = 150 mA (Note 28)	-	190	260	mV
I _{OUT}	Output Current	(Note 29)	150	-	-	mA
I _{SC}	Short Circuit Current Limit	V _{OUT} = 0 V	-	195	-	mA
l _Q	Quiescent Current	I _{OUT} = 0 mA	-	0.5	0.9	μA
I _{STB}	Standby Current	$V_{EN} = 0 V, T_{J} = 25^{\circ}C$	-	0.1	0.5	μA
V _{ENH}	EN Pin Threshold Voltage	EN Input Voltage "H"	1.2	-	-	V
V _{ENL}	EN Pin Threshold Voltage	EN Input Voltage "L"	-	-	0.4	V
I _{EN}	EN Pull Down Current	$V_{EN} \le V_{IN} \le 5.5 \text{ V}$ (Note 30)	-	10	-	nA
PSRR	Power Supply Rejection Ratio	f = 1 kHz, V_{IN} = 4.0 V + 200 mVpp Modulation I _{OUT} = 150 mA	-	47	-	dB
V _{NOISE}	Output Noise Voltage	V_{IN} = 5.5 V, I_{OUT} = 1 mA f = 100 Hz to 1 MHz, C_{OUT} = 1 μF	-	120	-	μVrms
R _{LOW}	Active Output Discharge Resistance (A option only)	V _{IN} = 5.5 V, V _{EN} = 0 V (Note 30)	-	100	-	Ω
T _{SD}	Thermal Shutdown Temperature	Temperature Increasing from $T_J = +25^{\circ}C$ (Note 30)	-	175	-	°C
T _{SDH}	Thermal Shutdown Hysteresis	Temperature Falling from T _{SD} (Note 30)	-	25	-	°C

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 27.Performance guaranteed over the indicated operating temperature range by design and/or characterization production tested at

27. Performance guaranteed over the indicated operating temperature range by design and/or characterization production tested at T_J = T_A = 25°C. Low duty cycle pulse techniques are used during testing to maintain the junction temperature as close to ambient as possible.
 28. Characterized when V_{OUT} falls 90 mV below the regulated voltage and only for devices with V_{OUT} = 3.0 V.

29. Respect SOA.

ELECTRICAL CHARACTERISTICS - VOLTAGE VERSION 3.3 V

 $(-40^{\circ}C \le T_J \le 85^{\circ}C; V_{IN} = 4.3 \text{ V}; I_{OUT} = 1 \text{ mA}, C_{IN} = C_{OUT} = 1.0 \mu\text{F}, \text{ unless otherwise noted. Typical values are at } T_A = +25^{\circ}C.)$ (Note 31)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
V _{IN}	Operating Input Voltage		2.2	-	5.5	V
V _{OUT}	Output Voltage	$T_A = +25^{\circ}C$	3.267	3.3	3.333	V
		$-40^{\circ}C \leq T_J \leq 85^{\circ}C$	3.234	3.3	3.366	
Line _{Reg}	Line Regulation	4.3 V < V _{IN} \leq 5.5 V, I _{OUT} = 1 mA	-	0.05	0.20	%/V
Load _{Reg}	Load Regulation	0 mA < I _{OUT} \leq 150 mA, V _{IN} = 4.3 V	-20	1	20	mV
V _{DO}	Dropout Voltage	I _{OUT} = 150 mA (Note 32)	-	180	250	mV
I _{OUT}	Output Current	(Note 33)	150	-	-	mA
I _{SC}	Short Circuit Current Limit	V _{OUT} = 0 V	-	195	-	mA
Ι _Q	Quiescent Current	I _{OUT} = 0 mA	-	0.5	0.9	μΑ
I _{STB}	Standby Current	$V_{EN} = 0 \text{ V}, \text{ T}_{J} = 25^{\circ}\text{C}$	-	0.1	0.5	μΑ
V _{ENH}	EN Pin Threshold Voltage	EN Input Voltage "H"	1.2	-	-	V
V _{ENL}	EN Pin Threshold Voltage	EN Input Voltage "L"	-	-	0.4	V
I _{EN}	EN Pull Down Current	$V_{EN} \le V_{IN} \le 5.5 \text{ V}$ (Note 34)	-	10	-	nA
PSRR	Power Supply Rejection Ratio	f = 1 kHz, V _{IN} = 4.3 V + 200 mVpp Modulation I_{OUT} = 150 mA	-	41	-	dB
V _{NOISE}	Output Noise Voltage	V_{IN} = 5.5 V, I_{OUT} = 1 mA f = 100 Hz to 1 MHz, C_{OUT} = 1 μF	-	125	-	μVrms
R _{LOW}	Active Output Discharge Resistance (A option only)	V _{IN} = 5.5 V, V _{EN} = 0 V (Note 34)	-	100	-	Ω
T _{SD}	Thermal Shutdown Temperature	Temperature Increasing from $T_J = +25^{\circ}C$ (Note 34)	-	175	-	°C
T _{SDH}	Thermal Shutdown Hysteresis	Temperature Falling from T _{SD} (Note 34)	-	25	-	°C

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 31.Performance guaranteed over the indicated operating temperature range by design and/or characterization production tested at

31. Performance guaranteed over the indicated operating temperature range by design and/or characterization production tested at T_J = T_A = 25°C. Low duty cycle pulse techniques are used during testing to maintain the junction temperature as close to ambient as possible.
 32. Characterized when V_{OUT} falls 99 mV below the regulated voltage and only for devices with V_{OUT} = 3.3 V.

33. Respect SOA.

ELECTRICAL CHARACTERISTICS - VOLTAGE VERSION 3.6 V

 $(-40^{\circ}C \le T_J \le 85^{\circ}C; V_{IN} = 4.6 \text{ V}; I_{OUT} = 1 \text{ mA}, C_{IN} = C_{OUT} = 1.0 \mu\text{F}, \text{ unless otherwise noted. Typical values are at } T_A = +25^{\circ}C.)$ (Note 35)

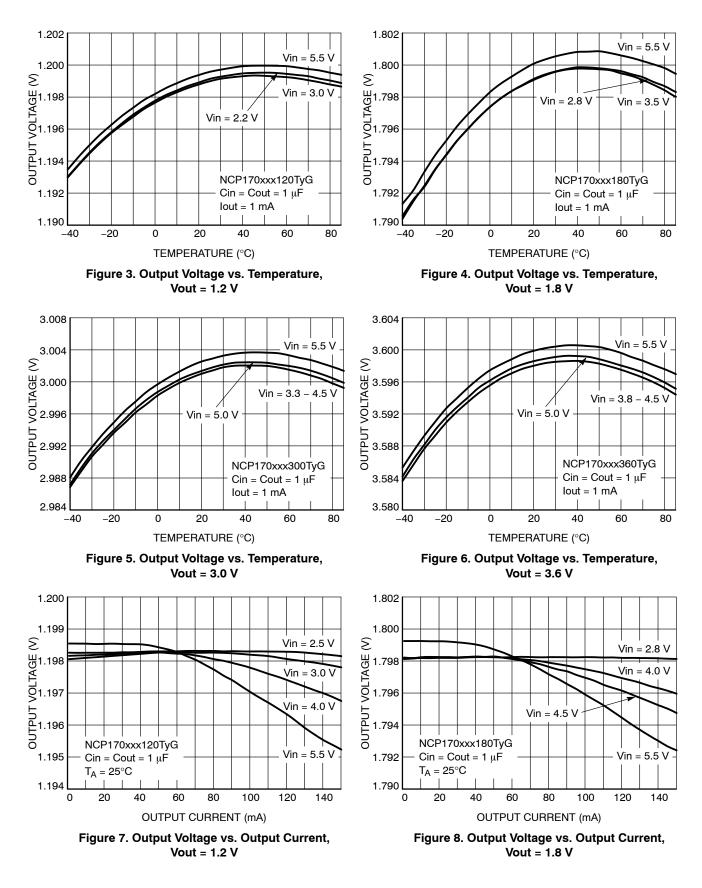
Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
V _{IN}	Operating Input Voltage		2.2	-	5.5	V
V _{OUT}	Output Voltage	$T_A = +25^{\circ}C$	3.564	3.6	3.636	V
		$-40^{\circ}C \le T_J \le 85^{\circ}C$	3.528	3.6	3.672	
Line _{Reg}	Line Regulation	$4.6 \text{ V} < \text{V}_{\text{IN}} \le 5.5 \text{ V}, \text{ I}_{\text{OUT}} = 1 \text{ mA}$	-	0.05	0.20	%/V
Load _{Reg}	Load Regulation	0 mA < $I_{OUT} \le 150$ mA, $V_{IN} = 4.6$ V	-20	1	20	mV
V_{DO}	Dropout Voltage	I _{OUT} = 150 mA (Note 36)	-	170	240	mV
I _{OUT}	Output Current	(Note 37)	150	-	-	mA
I _{SC}	Short Circuit Current Limit	V _{OUT} = 0 V	-	195	-	mA
l _Q	Quiescent Current	I _{OUT} = 0 mA	-	0.5	0.9	μA
I _{STB}	Standby Current	$V_{EN} = 0 \text{ V}, \text{T}_{\text{J}} = 25^{\circ}\text{C}$	-	0.1	0.5	μA
V_{ENH}	EN Pin Threshold Voltage	EN Input Voltage "H"	1.2	-	-	V
V _{ENL}	EN Pin Threshold Voltage	EN Input Voltage "L"	-	-	0.4	V
I _{EN}	EN Pull Down Current	$V_{EN} \le V_{IN} \le 5.5 \text{ V}$ (Note 38)	-	10	-	nA
PSRR	Power Supply Rejection Ratio	f = 1 kHz, V _{IN} = 4.6 V + 200 mVpp Modulation I _{OUT} = 150 mA	-	30	-	dB
V _{NOISE}	Output Noise Voltage	V _{IN} = 5.5 V, I _{OUT} = 1 mA f = 100 Hz to 1 MHz, C _{OUT} = 1 μF	-	130	-	μVrms
R _{LOW}	Active Output Discharge Resis- tance (A option only)	V _{IN} = 5.5 V, V _{EN} = 0 V (Note 34)	-	100	-	
T _{SD}	Thermal Shutdown Temperature	Temperature Increasing from $T_J = +25^{\circ}C$ (Note 38)	-	175	-	°C
T _{SDH}	Thermal Shutdown Hysteresis	Temperature Falling from T _{SD} (Note 38)	-	25	-	°C

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

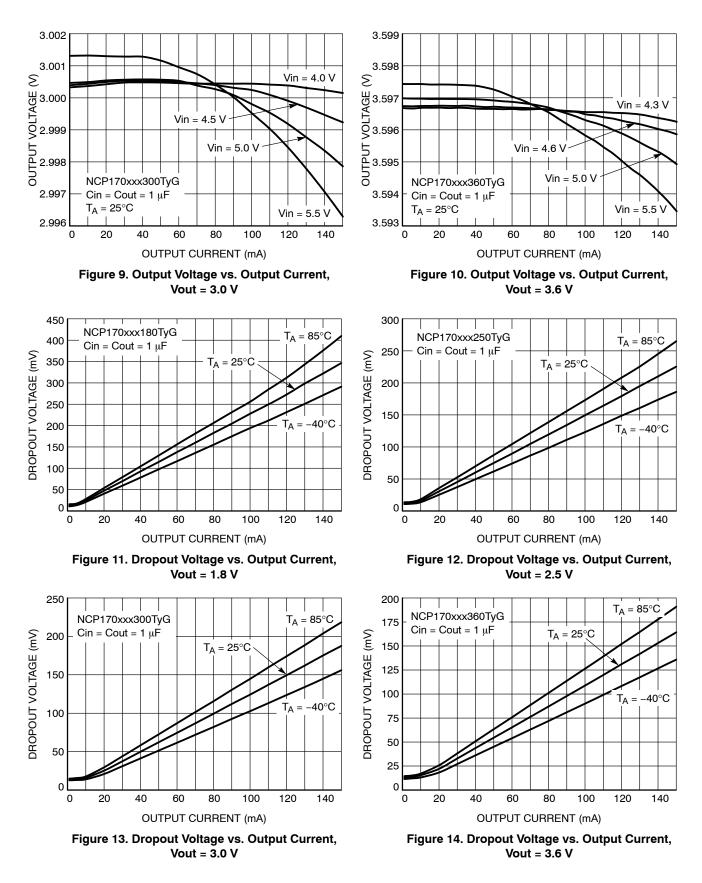
35. Performance guaranteed over the indicated operating temperature range by design and/or characterization production tested at $T_J = T_A = 25^{\circ}$ C. Low duty cycle pulse techniques are used during testing to maintain the junction temperature as close to ambient as possible. 36. Characterized when V_{OUT} falls 108 mV below the regulated voltage and only for devices with V_{OUT} = 3.6 V.

37. Respect SOA.

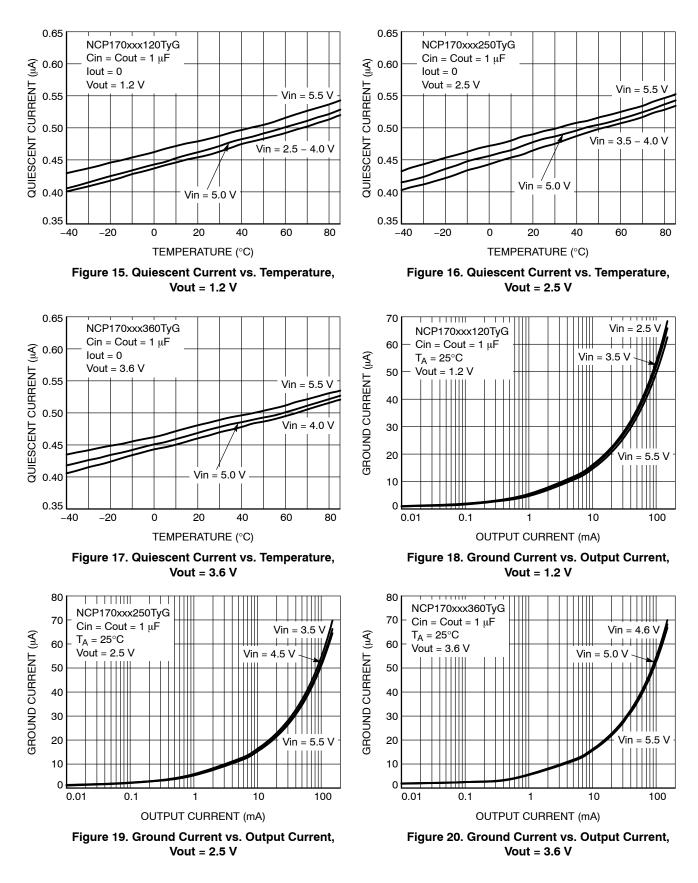
TYPICAL CHARACTERISTICS



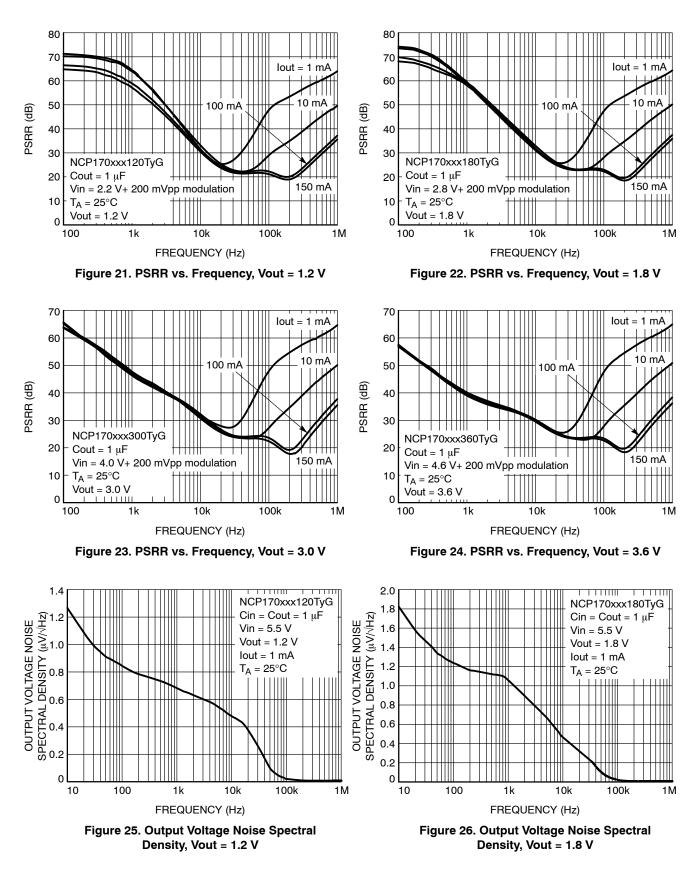
TYPICAL CHARACTERISTICS



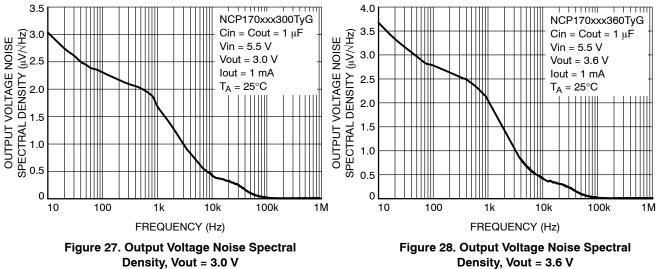




TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



Density, Vout = 3.6 V

TYPICAL CHARACTERISTICS

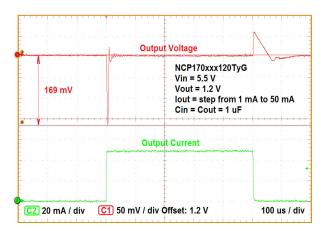


Figure 29. Load Transient Response at Load Step from 1 mA to 50 mA, Vout = 1.2 V

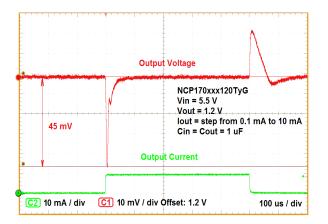
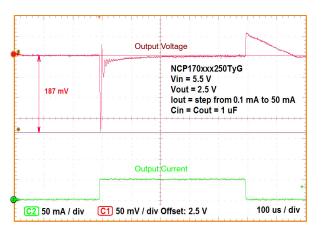
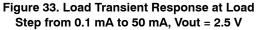


Figure 31. Load Transient Response at Load Step from 0.1 mA to 10 mA, Vout = 1.2 V





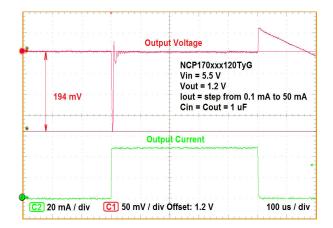


Figure 30. Load Transient Response at Load Step from 0.1 mA to 50 mA, Vout = 1.2 V

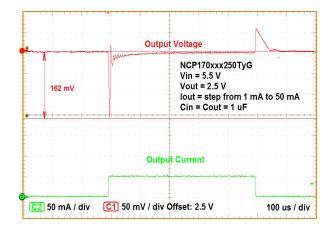
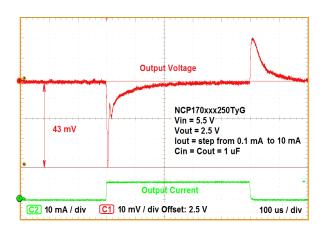
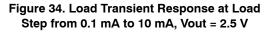


Figure 32. Load Transient Response at Load Step from 1 mA to 50 mA, Vout = 2.5 V





TYPICAL CHARACTERISTICS

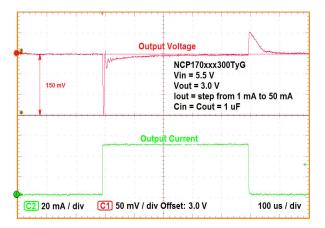


Figure 35. Load Transient Response at Load Step from 1mA to 50 mA, Vout= 3.0 V

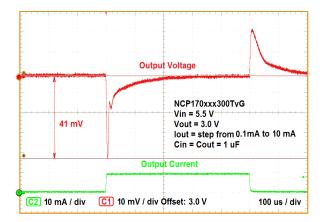
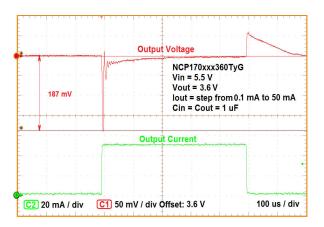
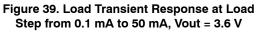


Figure 37. Load Transient Response at Load Step from 0.1 mA to 10 mA, Vout = 3.0 V





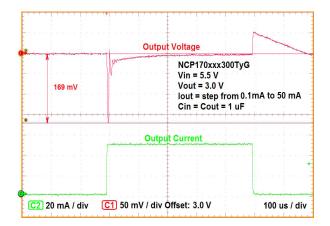


Figure 36. Load Transient Response at Load Step from 0.1 mA to 50 mA, Vout = 3.0 V

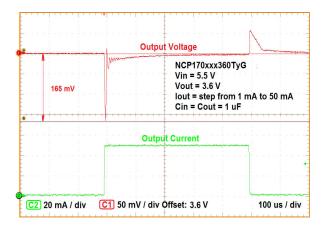
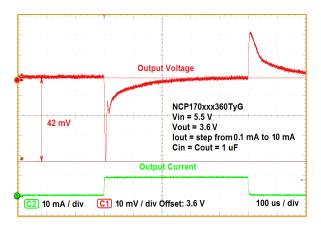
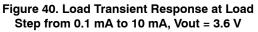


Figure 38. Load Transient Response at Load Step from 1 mA to 50 mA, Vout = 3.6 V





TYPICAL CHARACTERISTICS

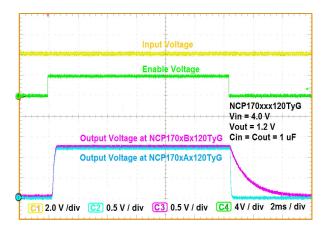


Figure 41. Output Voltage with and without Active Discharge Feature, Vout = 1.2 V

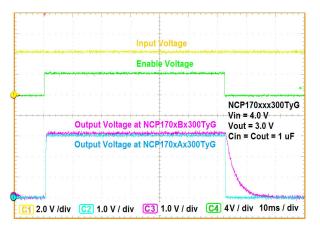


Figure 43. Output Voltage with and without Active Discharge Feature, Vout = 3.0 V

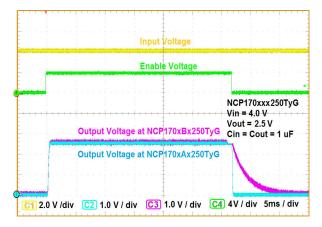


Figure 42. Output Voltage with and without Active Discharge Feature, Vout = 2.5 V

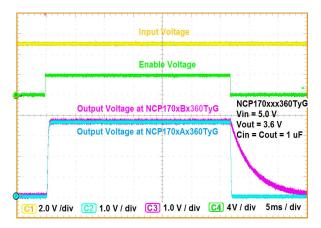


Figure 44. Output Voltage with and without Active Discharge Feature, Vout = 3.6 V

TYPICAL CHARACTERISTICS

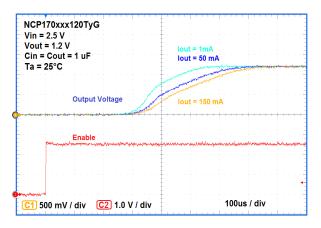


Figure 45. Enable Turn-on Response at Vout = 1.2 V

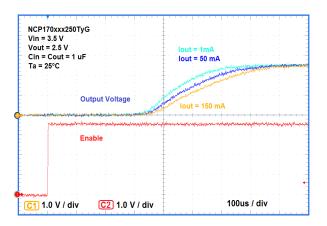


Figure 47. Enable Turn-on Response at Vout = 2.5 V

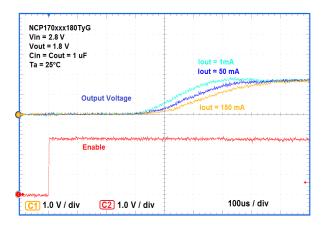


Figure 46. Enable Turn-on Response at Vout = 1.8 V

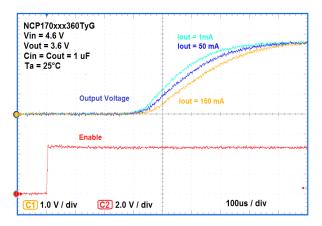


Figure 48. Enable Turn-on Response at Vout = 3.6 V

APPLICATIONS INFORMATION

General

The NCP170 is a high performance 150 mA Linear Regulator with Ultra Low IQ. This device delivers low Noise and high Power Supply Rejection Ratio with excellent dynamic performance due to employing the Dynamic Quiescent Current adjustment which assure ultra low I_Q consumption at no – load state. These parameters make this device very suitable for various battery powered applications.

Input Decoupling (CIN)

It is recommended to connect at least a 1 μ F Ceramic X5R or X7R capacitor between IN and GND pins of the device. This capacitor will provide a low impedance path for any unwanted AC signals or Noise superimposed onto constant Input Voltage. The good input capacitor will limit the influence of input trace inductances and source resistance during sudden load current changes.

Higher capacitance and lower ESR Capacitors will improve the overall line transient response.

Output Decoupling (COUT)

The NCP170 does not require a minimum Equivalent Series Resistance (ESR) for the output capacitor. The device is designed to be stable with standard ceramics capacitors with values of 1.0 μ F or greater up to 10 μ F. The X5R and X7R types have the lowest capacitance variations over temperature thus they are recommended. There is recommended connect the output capacitor as close as possible to the output pin of the regulator.

Enable Operation

The NCP170 uses the EN pin to enable /disable its device and to activate /deactivate the active discharge function at devices with this feature. If the EN pin voltage is pulled below 0.4 V the device is guaranteed to be disable. The active discharge transistor at the devices with Active Discharge Feature is activated and the output voltage VOUT is pulled to GND through an internal circuitry with effective resistance about 100 ohms.

If the EN pin voltage is higher than 1.2 V the device is guaranteed to be enabled. The internal active discharge circuitry is switched off and the desired output voltage is available at output pin. In case the Enable function is not required the EN pin should be connected directly to input pin.

Thermal Shutdown

When the die temperature exceeds the Thermal Shutdown point (TSD = 175° C typical) the device goes to disabled state and the output voltage is not delivered until the die temperature decreases to 150° C. The Thermal Shutdown feature provides a protection from a catastrophic device failure at accidental overheating. This protection is not intended to be used as a substitute for proper heat sinking.

Power Dissipation and Heat sinking

The maximum power dissipation supported by the device is dependent upon board design and layout. Mounting pad configuration on the PCB, the board material, and the ambient temperature affect the rate of junction temperature rise for the part. For reliable operation, junction temperature should be limited to +125°C. The maximum power dissipation the NCP170 device can handle is given by:

$$\mathsf{P}_{\mathsf{D}(\mathsf{MAX})} = \frac{\left[\mathsf{T}_{\mathsf{J}(\mathsf{MAX})} - \mathsf{T}_{\mathsf{A}}\right]}{\mathsf{R}_{\theta,\mathsf{J}\mathsf{A}}} \qquad (\mathsf{eq. 1})$$

The power dissipated by the NCP170 device for given application conditions can be calculated from the following equations:

$$\mathsf{P}_\mathsf{D} \approx \mathsf{V}_\mathsf{IN} \big(\mathsf{I}_\mathsf{GND} (\mathsf{I}_\mathsf{OUT}) \big) + \mathsf{I}_\mathsf{OUT} \big(\mathsf{V}_\mathsf{IN} - \mathsf{V}_\mathsf{OUT} \big) \qquad (\mathsf{eq. 2})$$

or

$$V_{\text{IN(MAX)}} \approx \frac{\mathsf{P}_{\text{D(MAX)}} + \left(\mathsf{V}_{\text{OUT}} \times \mathsf{I}_{\text{OUT}}\right)}{\mathsf{I}_{\text{OUT}} + \mathsf{I}_{\text{GND}}} \tag{eq. 3}$$

Hints

VIN and GND printed circuit board traces should be as wide as possible. When the impedance of these traces is high, there is a chance to pick up noise or cause the regulator to malfunction. Place external components, especially the output capacitor, as close as possible to the NCP170, and make traces as short as possible.

ORDERING INFORMATION

Device	Nominal Output Voltage	Marking	Active Discharge	Package	Shipping [†]
NCP170AMX120TCG (Note 39)	1.2	AC	-	XDFN4 1.0 × 1.0 (Pb-Free)	3000 or 5000 / Tape & Reel (Note 39)
NCP170AMX129TCG	1.29	AV			
NCP170AMX135TCG (Note 39)	1.35	AP			
NCP170AMX150TCG (Note 39)	1.5	AJ			
NCP170AMX170TCG	1.7	AT			
NCP170AMX180TBG (Note 39)	1.8	AD			
NCP170AMX180TCG (Note 39)	1.8	AD			
NCP170AMX190TCG	1.9	AL			
NCP170AMX250TCG (Note 39)	2.5	AE			
NCP170AMX280TBG (Note 39)	2.8	AF	Yes		
NCP170AMX280TCG (Note 39)	2.8	AF			
NCP170AMX285TCG (Note 39)	2.85	AK			
NCP170AMX300TBG (Note 39)	3.0	AA			
NCP170AMX300TCG (Note 39)	3.0	AA			
NCP170AMX310TCG	3.1	AN			
NCP170AMX320TCG	3.2	AQ			
NCP170AMX330TBG (Note 39)	3.3	AG			
NCP170AMX330TCG (Note 39)	3.3	AG			
NCP170AMX360TCG (Note 39)	3.6	AM			
NCP170BMX120TCG	1.2	2C	-		
NCP170BMX135TCG (Note 39)	1.35	2P			
NCP170BMX150TCG (Note 39)	1.5	2J			
NCP170BMX170TCG	1.7	2T			
NCP170BMX180TCG (Note 39)	1.8	2D			
NCP170BMX190TCG (Note 39)	1.9	2L	1		
NCP170BMX250TCG (Note 39)	2.5	2E	N-		
NCP170BMX280TCG (Note 39)	2.8	2F	No		
NCP170BMX285TCG (Note 39)	2.85	2K			
NCP170BMX300TCG (Note 39)	3.0	2A			
NCP170BMX310TCG (Note 39)	3.1	2N			
NCP170BMX320TCG	3.2	2Q			
NCP170BMX330TCG (Note 39)	3.3	2G			
NCP170BMX360TCG (Note 39)	3.6	2M			

ORDERING INFORMATION

Device	Nominal Output Voltage	Marking	Active Discharge	Package	Shipping [†]
NCP170AXV120T2G	1.2	AC			-
NCP170AXV135T2G	1.35	AL			
NCP170AXV150T2G	1.5	AJ			
NCP170AXV180T2G	1.8	AD			
NCP170AXV190T2G	1.9	AM			
NCP170AXV210T2G	2.1	AK		Yes	4000 / Tape & Reel (Available Soon)
NCP170AXV250T2G	2.5	AE	Yes		
NCP170AXV280T2G	2.8	AF			
NCP170AXV300T2G	3.0	AA	SOT-563 (Pb-Free)		
NCP170AXV310T2G	3.1	AN			
NCP170AXV330T2G	3.3	AH			
NCP170AXV360T2G	3.6	AG			
NCP170BXV120T2G	1.2	2C	No		
NCP170BXV135T2G	1.35	2L			
NCP170BXV150T2G	1.5	2J			
NCP170BXV180T2G	1.8	2D			
NCP170BXV190T2G	1.9	2M			
NCP170BXV250T2G	2.5	2E			
NCP170BXV280T2G	2.8	2F			
NCP170BXV300T2G	3.0	2A			
NCP170BXV310T2G	3.1	2N			
NCP170BXV330T2G	3.3	2H			
NCP170ASN120T2G	1.2	GCG		TSOP-5 (Pb-Free)	3000 / Tape & Reel (Available Soon)
NCP170ASN129T2G	1.29	GCJ			
NCP170ASN150T2G	1.5	GCH			
NCP170ASN180T2G	1.8	GCF) Vaa		
NCP170ASN250T2G	2.5	GCE			
NCP170ASN280T2G	2.8	GCA			
NCP170ASN300T2G	3.0	GCC			
NCP170ASN330T2G	3.3	GCD	1		

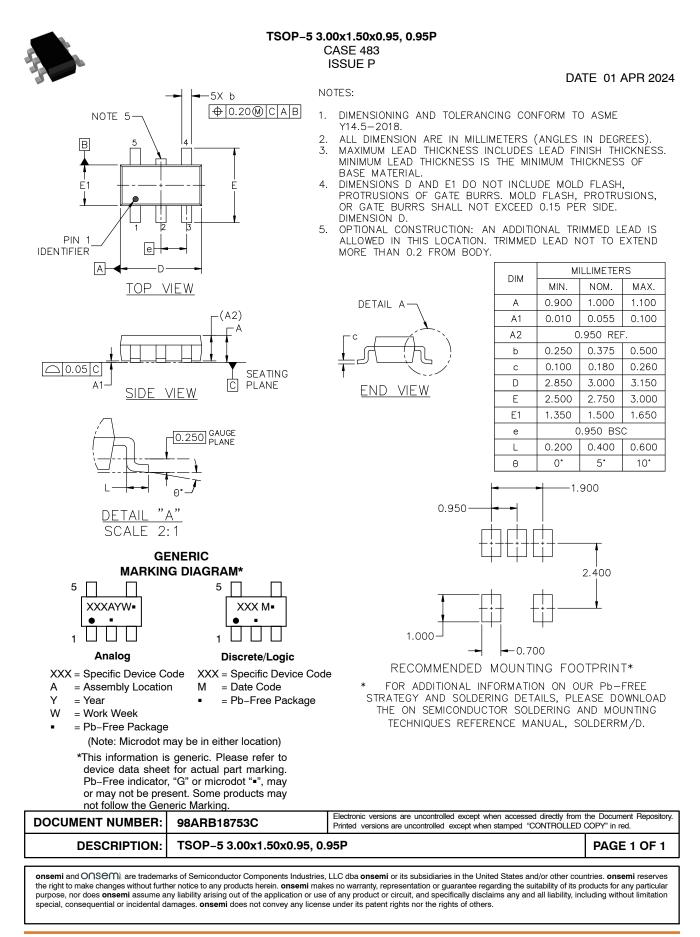
†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.
39. Product processed after October 1, 2022 are shipped with quantity 5000 units / tape & reel.



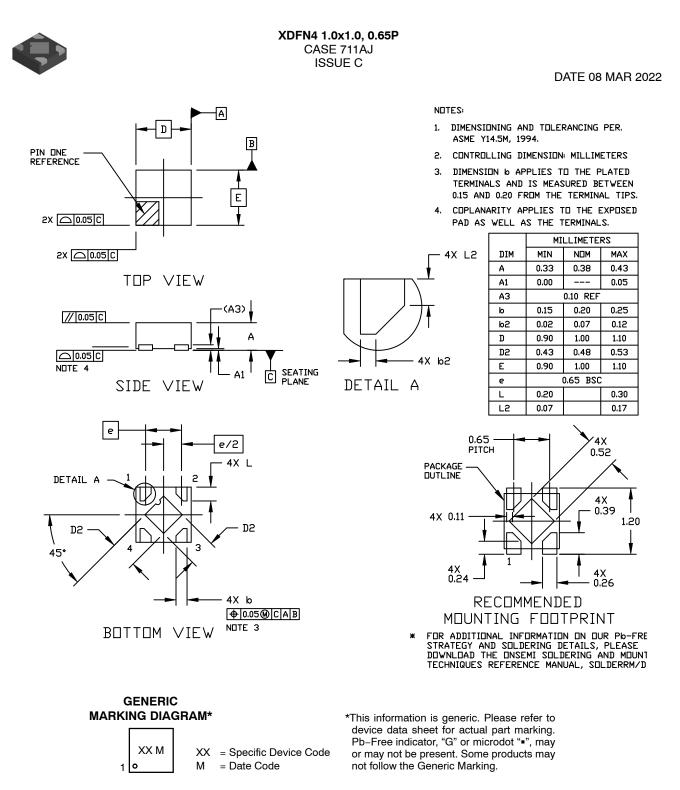
SOT-563-6 1.60x1.20x0.55, 0.50P CASE 463A ISSUE J DATE 15 FEB 2024 NOTES: 1. DIMENSIONING AND TOLERANCING CONFORM TO ASME Y14.5-2018. 2. ALL DIMENSION ARE IN MILLIMETERS. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM 3 THICKNESS OF BASE MATERIAL. -A D MILLIMETERS А 6X L DIM В MIN NDM. MAX. m 0.50 0.55 А 0.60 ł 6 4 PIN b 0.17 0.22 0.27 F Н REFERENCE C 0.08 0.13 0.18 2 ັບ 1 3 D 1.50 1.60 1.70 E 1.20 1.30 1.10 -⊨ 6X b C ⊕ 0.08∭ A B е 0.50 BSC е Н 1.50 1.60 1.70 TOP VIEW SIDE VIEW L 0.10 0.20 0.30 1.30 6X 0.45 0.30 1.80 STYLE 1: STYLE 2 STYLE 3 PIN 1. EMITTER 1 2. BASE 1 PIN 1. EMITTER 1 PIN 1. CATHODE 1 2. CATHODE 1 2. EMITTER 2 3. COLLECTOR 2 3. BASE 2 3. ANDDE/ANDDE 2 4. EMITTER 2 4. COLLECTOR 2 4. CATHODE 2 0.50 5. BASE 2 5. BASE 1 5. CATHODE 2 6. COLLECTOR 1 PITCH 6. COLLECTOR 1 6. ANDDE/ANDDE 1 RECOMMENDED MOUNTING FOOTPRINT* STYLE 6: PIN 1. CATHODE 2. ANODE FOR ADDITIONAL INFORMATION ON OUR Pb-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ON SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE STYLE 5 STYLE 4: 1. CATHODE 2. CATHODE PIN 1. COLLECTOR PIN 2. COLLECTOR 3. BASE 3. ANDDE 3. CATHODE 4. ANDDE 5. CATHODE 4. CATHODE 5. CATHODE 4. EMITTER MANUAL, SOLDERRM/D. 5, COLLECTOR 6. COLLECTOR 6. CATHODE 6. CATHODE GENERIC **MARKING DIAGRAM*** STYLE 7: STYLE 8 STYLE 9 PIN 1. CATHODE PIN 1. DRAIN PIN 1. SOURCE 1 2. ANDDE 2. DRAIN 2. GATE 1 XXM. 3. CATHODE 4. CATHODE 3. GATE 4. SDURCE 5. DRAIN 3. DRAIN 2 4. SDURCE 2 5. GATE 2 1 5. ANDDE 6. CATHODE 6. DRAIN 6. DRAIN 1 XX = Specific Device Code M = Month Code = Pb-Free Package STYLE 10: STYLE 11: *This information is generic. Please refer to PIN 1. CATHODE 1 PIN 1. EMITTER 2 device data sheet for actual part marking. 2. N/C 3. CATHODE 2 2. BASE 2 3. COLLECTOR 1 Pb-Free indicator, "G" or microdot "•", may 4. ANDDE 2 EMITTER 1 4. or may not be present. Some products may BASE 5. N/C 5. not follow the Generic Marking. 6. ANDDE 1 COLLECTOR 2 6. Electronic versions are uncontrolled except when accessed directly from the Document Repository. **DOCUMENT NUMBER:** 98AON11126D Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. **DESCRIPTION:** SOT-563-6 1.60x1.20x0.55, 0.50P PAGE 1 OF 1

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